Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	FR81S
Core Size	32-Bit Single-Core
Speed	128MHz
Connectivity	CANbus, CSIO, I²C, LINbus, SPI, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	98
Program Memory Size	832KB (832K x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	72K x 8
Voltage - Supply (Vcc/Vdd)	3.7V ~ 5.5V
Data Converters	A/D 24x12b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb91f586lapmc-gtk5e1

MB91580S Series Product Lineup Comparison

- Memory size

Items	MB91F583SG MB91F583SH MB91F583SJ MB91F583SK	MB91F584SG MB91F584SH MB91F584SJ MB91F584SK	MB91F585SG MB91F585SH MB91F585SJ MB91F585SK
Flash memory capacity (program)	256+64 Kbytes	384+64 Kbytes	512+64 Kbytes
Flash memory capacity (work)	64 Kbytes		
RAM capacity (main)	32 Kbytes	48 Kbytes	48 Kbytes
RAM capacity (backup)	8 Kbytes		

- Function

Items	MB91F583SG MB91F584SG MB91F585SG	MB91F583SH MB91F584SH MB91F585SH	MB91F583SJ MB91F584SJ MB91F585SJ	MB91F583SK MB91F584SK MB91F585SK
System clock	On-chip PLL clock multiplication system (Up to 32 times of multiplication) Minimum instruction execution time: 7.81ns (128MHz, source oscillation 4MHz × 32 times of multiplication)			
CR oscillation	Provided			
Oscillation stop feature during stand-by	Provided	Provided	Not provided	Not provided
External bus interface	Not provided			
DMA transfer	8 channels			
16-bit base timer	2 channels			
Free-run timer	6 channels			
Input capture	4 channels			
Output compare	7 channels			
Waveform generator	2 unit (7channels)			
16-bit reload timer	4 channels			
PPG	6 channels			
External interrupt	7 channels			
A/D converter	3 units (17 channels)			
R/D converter	Not provided			
D/A converter	Provided			
Up/ down counter	2 channels			
Multi-function serial interface	2 channels			
CAN	64msb × 1 channel (ch.0)			
FlexRay	128msb × 1unit (ch.A / ch.B)	Not provided	128msb × 1unit (ch.A / ch.B)	Not provided
Software watchdog	Provided			
Hardware watchdog	Provided			
CRC generation	2 channels			
Low-voltage detection reset (Internal low-voltage detection)	Provided			
Low-voltage detection reset (External low-voltage detection)	Provided			
Device package	LQFP-64			
Debug interface	Built-in OCD (On Chip Debug Unit)			

Note: For details on the MB91580S series, see the "MB91580M/S Series HARDWARE MANUAL".

Pin No.	Pin name	I/O circuit type*	Function
124	P131	D	General-purpose I/O port
	ADTG0		A/D converter ch.0 to ch.7 external trigger input pin
125	P132	D	General-purpose I/O port
	ADTG1		A/D converter ch.8 to ch.15 external trigger input pin
	SCS1		Multi-function serial ch.1 serial chip select I/O pin
126	P133	D	General-purpose I/O port
	ADTG2		A/D converter ch.16 to ch.23 external trigger input pin
	TX2		CAN transmission data 2 output pin
127	P134	E	General-purpose I/O port
	STOPWT		FlexRay Stopwatch input pin
	RX2		CAN reception data 2 input pin
	INT7		INT7 external interrupt input pin
	IN7		16-bit input capture ch.7 external pulse input pin
110	DEBUGIF	L	DEBUG I/F pin
121	P136	D	General-purpose I/O port
	DTTI0		Waveform generator output stop signal input pin 0
	MONCLK		Clock monitor output pin
122	P137	D	General-purpose I/O port
	DTTI1		Waveform generator output stop signal input pin 1
40	AVCC0	-	R/D converter power supply
84	AVCC3	-	A/D converter analog power supply
42	AVRH0	-	R/D converter upper limit reference voltage power supply
52	AVRH1	-	A/D converter upper limit reference voltage
62	AVRH2	-	A/D converter upper limit reference voltage
83	AVRH3	-	A/D converter upper limit reference voltage
43	AVSS0	-	R/D converter GND
	AVRL0		R/D converter lower limit reference voltage
53	AVSS1	-	A/D converter GND
	AVRL1		A/D converter lower limit reference voltage
63	AVSS2	-	A/D converter GND
	AVRL2		A/D converter lower limit reference voltage
82	AVSS3	-	A/D converter GND
	AVRL3		A/D converter lower limit reference voltage
130	C	-	External capacity connection output
18, 36, 93, 72, 109, 128, 144	VCC5	-	+5.0V power supply
1, 19, 37, 73, 94, 108, 120, 129	VSS	-	GND

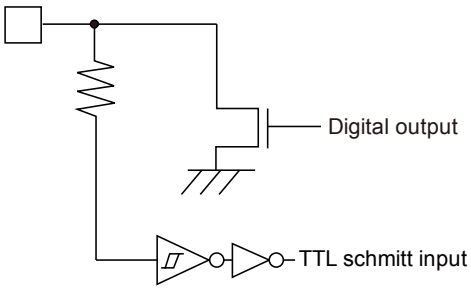
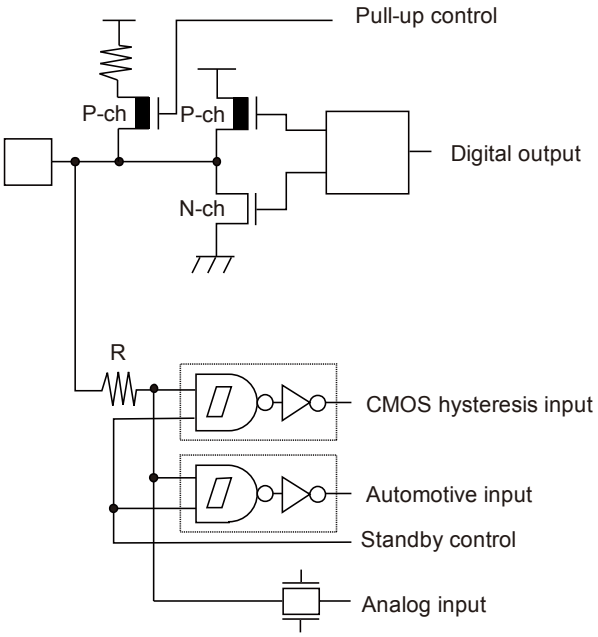
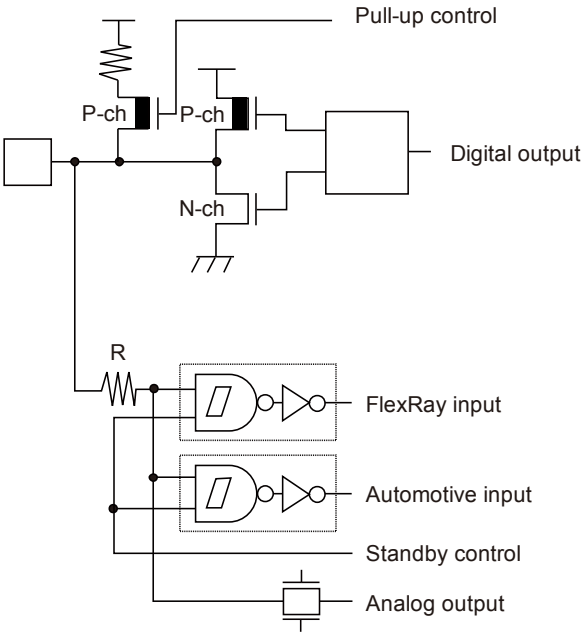
*: For the I/O circuit types, see "■ I/O circuit type".

• MB91F585LB/F586LB/F587LB/F585LD/F586LD/F587LD

Pin No.	Pin name	I/O circuit type*1	Function
118	X0	A	Main clock oscillation input pin
119	X1		Main clock oscillation output pin
95	NMIX	B	Interrupt input pin without mask
123	RSTX	B	External reset input pin
116	MD0	C	Mode pin 0 (with high-voltage control)
117	MD1	C	Mode pin 1 (with high-voltage control)
131	P000	E	General-purpose I/O port
	D16		External bus data bit16 I/O pin
	INT2		INT2 external interrupt input pin
	SIN1		Multi-function serial ch.1 serial data input pin
132	P001	K	General-purpose I/O port
	D17		External bus data bit17 I/O pin
	SOT1		Multi-function serial ch.1 serial data output pin/ I^2C ch.1 serial data I/O pin (SDA)
133	P002	K	General-purpose I/O port
	D18		External bus data bit18 I/O pin
	SCK1		Multi-function serial ch.1 clock I/O pin / I^2C ch.1 clock I/O pin (SCL)
134	P003	O	General-purpose I/O port
	D19		External bus data bit19 I/O pin
	TXENA		FlexRay ch.A operation enable output pin
	INT3		INT3 external interrupt input pin
	SIN2		Multi-function serial ch.2 serial data input pin
135	P004	N	General-purpose I/O port
	D20		External bus data bit20 I/O pin
	TXDA		FlexRay ch.A data output pin
	SOT2		Multi-function serial ch.2 serial data output pin
136	P005	N	General-purpose I/O port
	D21		External bus data bit21 I/O pin
	RXDA		FlexRay ch.A data input pin
	SCK2		Multi-function serial ch.2 clock I/O pin
137	P006	N	General-purpose I/O port
	D22		External bus data bit22 I/O pin
	TXENB		FlexRay ch.B operation enable output pin
	SCS2		Multi-function serial ch.2 serial chip select I/O pin
138	P007	N	General-purpose I/O port
	D23		External bus data bit23 I/O pin
	TXDB		FlexRay ch.B data output pin
139	P010	N	General-purpose I/O port
	D24		External bus data bit24 I/O pin
	RXDB		FlexRay ch.B data input pin
140	P011	D	General-purpose I/O port
	D25		External bus data bit25 I/O pin
	TIOA0		Base timer ch.0 TIOA I/O pin

Pin No.	Pin name	I/O circuit type*1	Function
11	P026	K	General-purpose I/O port
	A00		External bus address bit0 output pin
	TIN3		Reload timer ch.3 event input pin
	SCK4_1		Multi-function serial ch.4 clock I/O pin (1)/ I^2C ch.4 clock I/O pin (1) (SCL)
12	P027	D	General-purpose I/O port
	A01		External bus address bit1 output pin
	TOT0		Reload timer ch.0 output pin
	SCS40_1		Multi-function serial ch.4 serial chip select 0 I/O pin (1)
13	P030	D	General-purpose I/O port
	A02		External bus address bit2 output pin
	TOT1		Reload timer ch.1 output pin
	SCS41_1		Multi-function serial ch.4 serial chip select 1 output pin (1)
14	P031	D	General-purpose I/O port
	A03		External bus address bit3 output pin
	TOT2		Reload timer ch.2 output pin
	SCS42_1		Multi-function serial ch.4 serial chip select 2 output pin (1)
15	P032	D	General-purpose I/O port
	A04		External bus address bit4 output pin
	TOT3		Reload timer ch.3 output pin
	SCS43_1		Multi-function serial ch.4 serial chip select 3 output pin (1)
16	P033	D	General-purpose I/O port
	A05		External bus address bit5 output pin
17	P034	D	General-purpose I/O port
	A06		External bus address bit6 output pin
20	P035	D	General-purpose I/O port
	A07		External bus address bit7 output pin
	AIN0		Up/ down counter ch.0 AIN input pin
21	P036	D	General-purpose I/O port
	A08		External bus address bit8 output pin
	BIN0		Up/ down counter ch.0 BIN input pin
22	P037	D	General-purpose I/O port
	A09		External bus address bit9 output pin
	ZIN0		Up/ down counter ch.0 ZIN input pin
23	P040	D	General-purpose I/O port
	A10		External bus address bit10 output pin
	AIN1		Up/ down counter ch.1 AIN input pin
24	P041	D	General-purpose I/O port
	A11		External bus address bit11 output pin
	BIN1		Up/ down counter ch.1 BIN input pin
25	P042	D	General-purpose I/O port
	A12		External bus address bit12 output pin
	ZIN1		Up/ down counter ch.1 ZIN input pin
26	P043	D	General-purpose I/O port
	A13		External bus address bit13 output pin

Pin No.	Pin name	I/O circuit type*1	Function
70	P086	F	General-purpose I/O port
	AN14		ADC analog 14 input pin
	PPG6		PPG ch.6 output pin
71	P087	F	General-purpose I/O port
	AN15		ADC analog 15 input pin
	PPG7		PPG ch.7 output pin
74	P090	D	General-purpose I/O port
	IN0		16-bit input capture ch.0 external pulse input pin
75	P091	D	General-purpose I/O port
	IN1		16-bit input capture ch.1 external pulse input pin
76	P092	D	General-purpose I/O port
	IN2		16-bit input capture ch.2 external pulse input pin
77	P093	D	General-purpose I/O port
	IN3		16-bit input capture ch.3 external pulse input pin
78	P094	D	General-purpose I/O port
	IN4		16-bit input capture ch.4 external pulse input pin
79	P095	D	General-purpose I/O port
	TX0		CAN transmission data 0 output pin
80	P096	E	General-purpose I/O port
	RX0		CAN reception data 0 input pin
	INT0		INT0 external interrupt input pin
81	P097	D	General-purpose I/O port
	IN5		16-bit input capture ch.5 external pulse input pin
85	P100	F	General-purpose I/O port
	PPG8		PPG ch.8 output pin
	AN16		ADC analog 16 input pin
86	P101	F	General-purpose I/O port
	PPG9		PPG ch.9 output pin
	AN17		ADC analog 17 input pin
87	P102	F	General-purpose I/O port
	PPG10		PPG ch.10 output pin
	AN18		ADC analog 18 input pin
88	P103	F	General-purpose I/O port
	PPG11		PPG ch.11 output pin
	AN19		ADC analog 19 input pin
89	P104	F	General-purpose I/O port
	PPG12		PPG ch.12 output pin
	AN20		ADC analog 20 input pin
90	P105	F	General-purpose I/O port
	PPG13		PPG ch.13 output pin
	AN21		ADC analog 21 input pin
91	P106	F	General-purpose I/O port
	PPG14		PPG ch.14 output pin
	AN22		ADC analog 22 input pin
92	P107	F	General-purpose I/O port
	PPG15		PPG ch.15 output pin
	AN23		ADC analog 23 input pin

Type	Circuit	Remarks
L		Open drain I/O
M		• With analog input, I^2C, general-purpose I/O port • CMOS level output I_{OH}=-3mA, I_{OL}=3mA (at I^2C output) I_{OH}=-2/-5mA, I_{OL}=2/5mA (other than above) • With 50 kΩ pull-up resistor control • CMOS hysteresis input (0.7Vcc/0.3Vcc) • Automotive input (0.8Vcc/0.5Vcc)
N		• With analog output, general-purpose I/O port • CMOS level output I_{OH}=-2/-4mA, I_{OL}=2/4mA • With 50 kΩ pull-up resistor control • FlexRay input (0.7Vcc/0.3Vcc) • Automotive input (0.8Vcc/0.5Vcc)

- Observance of Safety Regulations and Standards

  Most countries in the world have established standards and regulations regarding safety, protection from electromagnetic interference, etc. Customers are requested to observe applicable regulations and standards in the design of products.

- Fail-Safe Design

  Any semiconductor devices have inherently a certain rate of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

- Precautions Related to Usage of Devices

  Spansion semiconductor devices are intended for use in standard applications (computers, office automation and other office equipment, industrial, communications, and measurement equipment, personal or household devices, etc.).

  CAUTION: Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, sea floor repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

2. Precautions for Package Mounting

Package mounting may be either lead insertion type or surface mount type. In either case, for heat resistance during soldering, you should only mount under Spansion's recommended conditions. For detailed information about mount conditions, contact your sales representative.

- Lead Insertion Type

  Mounting of lead insertion type packages onto printed circuit boards may be done by two methods: direct soldering on the board, or mounting by using a socket.

  Direct mounting onto boards normally involves processes for inserting leads into through-holes on the board and using the flow soldering (wave soldering) method of applying liquid solder. In this case, the soldering process usually causes leads to be subjected to thermal stress in excess of the absolute ratings for storage temperature. Mounting processes should conform to Spansion recommended mounting conditions.

  If socket mounting is used, differences in surface treatment of the socket contacts and IC lead surfaces can lead to contact deterioration after long periods. For this reason it is recommended that the surface treatment of socket contacts and IC leads be verified before mounting.

- Surface Mount Type

  Surface mount packaging has longer and thinner leads than lead-insertion packaging, and therefore leads are more easily deformed or bent. The use of packages with higher pin counts and narrower pin pitch results in increased susceptibility to open connections caused by deformed pins, or shorting due to solder bridges.

  You must use appropriate mounting techniques. Spansion Inc. recommends the solder reflow method, and has established a ranking of mounting conditions for each product. Users are advised to mount packages in accordance with Spansion ranking of recommended conditions.

- Lead-Free Packaging
  CAUTION: When ball grid array (BGA) packages with Sn-Ag-Cu balls are mounted using Sn-Pb eutectic soldering, junction strength may be reduced under some conditions of use.

- Storage of Semiconductor Devices
  Because plastic chip packages are formed from plastic resins, exposure to natural environmental conditions will cause absorption of moisture. During mounting, the application of heat to a package that has absorbed moisture can cause surfaces to peel, reducing moisture resistance and causing packages to crack. To prevent, do the following:

  (1) Avoid exposure to rapid temperature changes, which cause moisture to condense inside the product. Store products in locations where temperature changes are slight.

  (2) Use dry boxes for product storage. Products should be stored below 70% relative humidity, and at temperatures between 5°C and 30°C.
  When you open Dry Package that recommends humidity 40% to 70% relative humidity.

  (3) When necessary, Spansion Inc. packages semiconductor devices in highly moisture-resistant aluminum laminate bags, with a silica gel desiccant. Devices should be sealed in their aluminum laminate bags for storage.

  (4) Avoid storing packages where they are exposed to corrosive gases or high levels of dust.

- Baking
  Packages that have absorbed moisture may be de-moisturized by baking (heat drying). Follow the Spansion recommended conditions for baking.

  Condition: 125°C/24 h

- Static Electricity
  Because semiconductor devices are particularly susceptible to damage by static electricity, you must take the following precautions:

  (1) Maintain relative humidity in the working environment between 40% and 70%. Use of an apparatus for ion generation may be needed to remove electricity.

  (2) Electrically ground all conveyors, solder vessels, soldering irons and peripheral equipment.

  (3) Eliminate static body electricity by the use of rings or bracelets connected to ground through high resistance (on the level of 1 MΩ).
  Wearing of conductive clothing and shoes, use of conductive floor mats and other measures to minimize shock loads is recommended.

  (4) Ground all fixtures and instruments, or protect with anti-static measures.

  (5) Avoid the use of styrofoam or other highly static-prone materials for storage of completed board assemblies.

■ APPLICATION NOTES

- Function Switching of a Multiplexed Port

  To switch between the port function and the multiplexed pin function, use the PFR (port function register). However, if a pin is also used for an external bus, its function is switched by the external bus setting. For details, see "I/O PORTS" in Hardware Manual.
  *: MB91F585LB/F586LB/F587LB/F585LD/F586LD/F587LD only

- Low-power Consumption Mode

  To transit to the sleep mode, watch mode, stop mode, watch mode(power-off) or stop mode(power-off), follow the procedure explained in the "Activating the sleep mode, watch mode, or stop mode" or the "Activating the watch mode (power-off) or stop mode(power-off)" of "POWER CONSUMPTION CONTROL" in Hardware Manual.

  Take the following notes when using a monitor debugger.

  - Do not set a break point for the low-power consumption transition program.
  - Do not execute an operation step for the low-power consumption transition program.

- Notes When Writing Data in a Register Having the Status Flag

  When writing data in the register that has a status flag (especially, an interrupt request flag) to control function, take care not to clear its status flag erroneously.
  The program must be written not to clear the flag to the status bit, and to set the control bits to have the desired value.
  Especially, if multiple control bits are used, the bit instruction cannot be used. (The bit instruction can access to a single bit only.) The Byte, Half-word, or Word access must be used to write data in the control bits and status flag simultaneously. During this time, take care not to clear other bits (in this case, the bits of status flag) erroneously.

  Note: These points can be ignored because the bit instructions already take the points into consideration for registers that support read-modify-write (RMW) operations. These points must be considered when using the bit instructions for registers that do not support RMW operations.

Address	Address offset value/Register name				Block
	+0	+1	+2	+3	
$0002E0_H$	-	GATEC0[R/W] B,H,W ------00	-	GATEC2[R/W] B,H,W ------00	PPG GATE Control
$0002E4_H$	-	GATEC4[R/W] B,H,W ------00	-	GATEC8[R/W] B,H,W ------00	
$0002E8_H$	-	GATEC10[R/W] B,H,W ------00	-	GATEC12[R/W] B,H,W ------00	
$0002EC_H$	-	-	-	-	Reserved
$0002F0_H$	RCRH0[W] H,W 00000000	RCRL0[W] B,H,W 00000000	UDCRH0[R] H,W 00000000	UDCRL0[R] B,H,W 00000000	U/D counter 0
$0002F4_H$	CCR0[R/W] B,H 00000000 -0001000		-	CSR0[R] B 00000000	
$0002F8_H$	RCRH1[W] H,W 00000000	RCRL1[W] B,H,W 00000000	UDCRH1[R] H,W 00000000	UDCRL1[R] B,H,W 00000000	U/D counter 1
$0002FC_H$	CCR1[R/W] B,H 00000000 -0001000		-	CSR1[R] B 00000000	
000300_H	-				Reserved
000304_H	-	-	-	-	Reserved
000308_H	-				Reserved
$00030C_H$	-	-	-	-	
000310_H	-	-	MPUCR[R/W] H 000000-0 ----0100		MPU [S] (Only the CPU can access this area)
000314_H	-	-	-	-	
000318_H	-				
$00031C_H$	-	-	-		
000320_H	DPVAR[R] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000324_H	-	-	DPVSR[R/W] H -------- 00000--0		
000328_H	DEAR[R] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$00032C_H$	-	-	DESR[R/W] H -------- 00000--0		
000330_H	PABR0[R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				
000334_H	-	-	PACR0[R/W] H 000000-0 00000--0		
000338_H	PABR1[R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				
$00033C_H$	-	-	PACR1[R/W] H 000000-0 00000--0		
000340_H	PABR2[R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				
000344_H	-	-	PACR2[R/W] H 000000-0 00000--0		
000348_H	PABR3[R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				
$00034C_H$	-	-	PACR3[R/W] H 000000-0 00000--0		
000350_H	PABR4[R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				

Address	Address offset value/Register name				Block
	+0	+1	+2	+3	
000588_H | $00058C_H$	-	-	-	-	Reserved
000590_H	PMUSTR [R/W] B,H,W 0-----1X	PMUCTLR[R/W] B,H,W 0-00----	PWRTMCTL[R/W] B,H,W -----011	-	PMU
000594_H	-	PMUINTF1[R/W] B,H,W 00000000	PMUINTF2[R/W] B,H,W -00-----	-	
000598_H	-	-	-	-	
$00059C_H$	-	-	-	-	
$0005A0_H$ | $0005FC_H$	-	-	-	-	Reserved
000600_H | $00060C_H$	-	-	-	-	Reserved [S]
000610_H | $00063C_H$	-	-	-	-	Reserved [S]
000640_H | $00064C_H$	-	-	-	-	Reserved [S]
000650_H | $00067C_H$	-	-	-	-	Reserved [S]
000680_H | $00068C_H$	-	-	-	-	Reserved [S]
000690_H | $0006BC_H$	-	-	-	-	Reserved [S]
$0006C0_H$ | $0006CC_H$	-	-	-	-	Reserved [S]
$0006D0_H$ | $0006F0_H$	-	-	-	-	Reserved
$0006F4_H$	-				Reserved
$0006F8_H$ | $0006FC_H$	-	-	-	-	Reserved
000700_H	-				Reserved
000704_H | $00070C_H$	-	-	-	-	Reserved
000710_H	BPCCRA[R/W] B 00000000	BPCCRB[R/W] B 00000000	BPCCRC[R/W] B 00000000	-	Bus performance counter
000714_H	BPCTRA[R/W] W 00000000 00000000 00000000 00000000				
000718_H	BPCTRB[R/W] W 00000000 00000000 00000000 00000000				
$00071C_H$	BPCTRC[R/W] W 00000000 00000000 00000000 00000000				

Address	Address offset value/Register name				Block
	+0	+1	+2	+3	
$000E00_H$	DDR00[R/W] B,H 00000000	DDR01[R/W] B,H 00000000	DDR02[R/W] B,H 00000000	DDR03[R/W] B,H 00000000	Data direction register
$000E04_H$	DDR04[R/W] B,H -----000	-	DDR06[R/W] B,H 00000000	DDR07[R/W] B,H 00000000	
$000E08_H$	DDR08[R/W] B,H 00000000	DDR09[R/W] B,H 00000000	DDR10[R/W] B,H 00000000	DDR11[R/W] B,H 00000000	
$000E0C_H$	DDR12[R/W] B,H 00000000	DDR13[R/W] B,H 00-00000	-	-	
$000E10_H$ | $000E1C_H$	-	-	-	-	Reserved
$000E20_H$	PFR00[R/W] B,H 00000000	PFR01[R/W] B,H 00000000	PFR02[R/W] B,H 00000000	PFR03[R/W] B,H 00000000	Port function register
$000E24_H$	PFR04[R/W] B,H -----000	-	PFR06[R/W] B,H 00000000	PFR07[R/W] B,H 00000000	
$000E28_H$	PFR08[R/W] B,H 00000000	PFR09[R/W] B,H 00000000	PFR10[R/W] B,H 00000000	PFR11[R/W] B,H 00000000	
$000E2C_H$	PFR12[R/W] B,H 00000000	PFR13[R/W] B,H 00-00000	-	-	
$000E30_H$ | $000E3C_H$	-	-	-	-	Reserved
$000E40_H$	PDDR00[R] B,H,W XXXXXXXX	PDDR01[R] B,H,W XXXXXXXX	PDDR02[R] B,H,W XXXXXXXX	PDDR03[R] B,H,W XXXXXXXX	Input data direct read register
$000E44_H$	PDDR04[R] B,H,W -----XXX	-	PDDR06[R] B,H,W XXXXXXXX	PDDR07[R] B,H,W XXXXXXXX	
$000E48_H$	PDDR08[R] B,H,W XXXXXXXX	PDDR09[R] B,H,W XXXXXXXX	PDDR10[R] B,H,W XXXXXXXX	PDDR11[R] B,H,W XXXXXXXX	
$000E4C_H$	PDDR12[R] B,H,W XXXXXXXX	PDDR13[R] B,H,W XX-XXXXX	-	-	
$000E50_H$ | $000E5C_H$	-	-	-	-	Reserved
$000E60_H$	EPFR00[R/W] B,H -----000	EPFR01[R/W] B,H ------00	EPFR02[R/W] B,H --000000	EPFR03[R/W] B,H 00000000	Extended port function register
$000E64_H$	EPFR04[R/W] B,H 00000000	EPFR05[R/W] B,H 00000000	EPFR06[R/W] B,H ------00	EPFR07[R/W] B,H ----0000	
$000E68_H$	EPFR08[R/W] B,H ----0000	EPFR09[R/W] B,H -------0	EPFR10[R/W] B,H 00000000	EPFR11[R/W] B,H ----0000	
$000E6C_H$	EPFR12[R/W] B,H --000000	EPFR13[R/W] B,H -------1	EPFR14[R/W] B,H -0000000	EPFR15[R/W] B,H -0000000	
$000E70_H$	EPFR16[R/W] B,H --000000	EPFR17[R/W] B,H 00000000	EPFR18[R/W] B,H 00000000	EPFR19[R/W] B,H 00000000	
$000E74_H$	EPFR20[R/W] B,H 00000000	EPFR21[R/W] B,H 00000000	EPFR22[R/W] B,H 00000000	EPFR23[R/W] B,H 00000000	
$000E78_H$	EPFR24[R/W] B,H 00000000	EPFR25[R/W] B,H 00000000	EPFR26[R/W] B,H 00000000	EPFR27[R/W] B,H 00000000	
$000E7C_H$	EPFR28[R/W] B,H 00000000	EPFR29[R/W] B,H 00000000	EPFR30[R/W] B,H 00000000	EPFR31[R/W] B,H 00000000	
$000E80_H$	EPFR32[R/W] B,H 00000000	-	-	-	

Address	Address offset value/Register name				Block
	+0	+1	+2	+3	
000588_H | $00058C_H$	-	-	-	-	Reserved
000590_H	PMUSTR [R/W] B,H,W 0-----1X	PMUCTLR[R/W] B,H,W 0-00----	PWRTMCTL[R/W] B,H,W -----011	-	PMU
000594_H	-	PMUINTF1[R/W] B,H,W 00000000	PMUINTF2[R/W] B,H,W -00-----	-	
000598_H	-	-	-	-	
$00059C_H$	-	-	-	-	
$0005A0_H$ | $0005FC_H$	-	-	-	-	Reserved
000600_H	ASR0[R/W] W 00000000 00000000 -------- 1111-001				External bus interface [S]
000604_H	ASR1[R/W] W XXXXXXXX XXXXXXXX -------- XXXX-XX0				
000608_H	ASR2[R/W] W XXXXXXXX XXXXXXXX -------- XXXX-XX0				
$00060C_H$	ASR3[R/W] W XXXXXXXX XXXXXXXX -------- XXXX-XX0				
000610_H | $00063C_H$	-	-	-	-	Reserved[S]
000640_H	ACR0[R/W] W -------- -------- -------- 00--00--				External bus interface [S]
000644_H	ACR1[R/W] W -------- -------- -------- XX--XX--				
000648_H	ACR2[R/W] W -------- -------- -------- XX--XX--				
$00064C_H$	ACR3[R/W] W -------- -------- -------- XX--XX--				
000650_H | $00067C_H$	-	-	-	-	Reserved[S]
000680_H	AWR0[R/W] W ----1111 00000000 11110000 00000-0-				External bus interface [S]
000684_H	AWR1[R/W] W ----XXXX XXXXXXXX XXXXXXXX XXXXX-X-				
000688_H	AWR2[R/W] W ----XXXX XXXXXXXX XXXXXXXX XXXXX-X-				
$00068C_H$	AWR3[R/W] W ----XXXX XXXXXXXX XXXXXXXX XXXXX-X-				
000690_H | $0006BC_H$	-	-	-	-	Reserved[S]
$0006C0_H$	DMAR0[R/W] W -------- -------- -------- ----0000				External bus interface [S]
$0006C4_H$	DMAR1[R/W] W -------- -------- -------- ----0000				
$0006C8_H$	DMAR2[R/W] W -------- -------- -------- ----0000				
$0006CC_H$	DMAR3[R/W] W -------- -------- -------- ----0000				

Address	Address offset value/Register name				Block
	+0	+1	+2	+3	
$0012A8_H$	ADCS1[R/W] B,H,W 0------- --------		ADCH1[R] B,H,W -----000	ADMD1[R/W] B,H,W ----0000	12-bit A/D converter
$0012AC_H$	ADCS2[R/W] B,H,W 0------- --------		ADCH2[R] B,H,W -----000	ADMD2[R/W] B,H,W ----0000	
$0012B0_H$ | $0012FC_H$	-	-	-	-	Reserved
001300_H	-	-	-	-	Reserved
001304_H	-	-	-	-	
001308_H	-	-	-	-	
$00130C_H$	-	-	-	-	
001310_H	-	-	-	-	
001314_H	-	-	-	-	
001318_H	-	-	-	-	
$00131C_H$	-	-	-	-	
001320_H	-	-	-	-	
001324_H	-		-		
001328_H	-	-	-	-	
$00132C_H$	-	-	-	-	
001330_H	-		-		
001334_H | $0013FC_H$	-	-	-	-	Reserved
001400_H	DACR[R/W] B,H,W -------0	-	DADR[R/W] H,W ------XX XXXXXXXX		DAC
001404_H | $0014FC_H$	-	-	-	-	Reserved

Address	Address offset value/Register name				Block
	+0	+1	+2	+3	
002044_H	IF2MSK20[R/W] B,H,W 11-11111 11111111		IF2MSK10[R/W] B,H,W 11111111 11111111		CAN 0 64msb
002048_H	IF2ARB20[R/W] B,H,W 00000000 00000000		IF2ARB10[R/W] B,H,W 00000000 00000000		
$00204C_H$	IF2MCTR0[R/W] B,H,W 00000000 0---0000		-		
002050_H	IF2DTA10[R/W] B,H,W 00000000 00000000		IF2DTA20[R/W] B,H,W 00000000 00000000		
002054_H	IF2DTB10[R/W] B,H,W 00000000 00000000		IF2DTB20[R/W] B,H,W 00000000 00000000		
002058_H, $00205C_H$	-		-		
002060_H, 002064_H	Reserved (IF2 data mirror)				
002068_H | $00207C_H$	-		-		
002080_H	TREQR20[R] B,H,W 00000000 00000000		TREQR10[R] B,H,W 00000000 00000000		
002084_H	TREQR40[R] B,H,W 00000000 00000000		TREQR30[R] B,H,W 00000000 00000000		
002088_H	-		-		
$00208C_H$	-		-		
002090_H	NEWDT20[R] B,H,W 00000000 00000000		NEWDT10[R] B,H,W 00000000 00000000		
002094_H	NEWDT40[R] B,H,W 00000000 00000000		NEWDT30[R] B,H,W 00000000 00000000		
002098_H	-		-		
$00209C_H$	-		-		
$0020A0_H$	INTPND20[R] B,H,W 00000000 00000000		INTPND10[R] B,H,W 00000000 00000000		
$0020A4_H$	INTPND40[R] B,H,W 00000000 00000000		INTPND30[R] B,H,W 00000000 00000000		
$0020A8_H$	-		-		
$0020AC_H$	-		-		
$0020B0_H$	MSGVAL20[R] B,H,W 00000000 00000000		MSGVAL10[R] B,H,W 00000000 00000000		
$0020B4_H$	MSGVAL40[R] B,H,W 00000000 00000000		MSGVAL30[R] B,H,W 00000000 00000000		
$0020B8_H$	-		-		
$0020BC_H$	-		-		
$0020C0_H$ | $0020FC_H$	-		-		
002100_H	CTRLR1[R/W] B,H,W -------- 000-0001		STATR1[R/W] B,H,W -------- 00000000		CAN 1 64msb
002104_H	ERRCNT1 [R] B,H,W 00000000 00000000		BTR1[R/W] B,H,W -0100011 00000001		
002108_H	INTR1[R] B,H,W 00000000 00000000		TESTR1[R/W] B,H,W -------- X00000--		
$00210C_H$	BRPER1[R/W] B,H,W -------- ----0000		-		
002110_H	IF1CREQ1[R/W] B,H,W 0------- 00000001		IF1CMSK1[R/W] B,H,W -------- 00000000		

Address	Address offset value/Register name				Block
	+0	+1	+2	+3	
002114_H	IF1MSK21[R/W] B,H,W 11-11111 11111111		IF1MSK11[R/W] B,H,W 11111111 11111111		CAN 1 64msb
002118_H	IF1ARB21[R/W] B,H,W 00000000 00000000		IF1ARB11[R/W] B,H,W 00000000 00000000		
$00211C_H$	IF1MCTR1[R/W] B,H,W 00000000 0---0000		-		
002120_H	IF1DTA11[R/W] B,H,W 00000000 00000000		IF1DTA21[R/W] B,H,W 00000000 00000000		
002124_H	IF1DTB11[R/W] B,H,W 00000000 00000000		IF1DTB21[R/W] B,H,W 00000000 00000000		
002128_H, $00212C_H$	-		-		
002130_H, 002134_H	Reserved (IF1 data mirror)				
002138_H, $00213C_H$	-		-		
002140_H	IF2CREQ1[R/W] B,H,W 0------- 00000001		IF2CMSK1[R/W] B,H,W -------- 00000000		
002144_H	IF2MSK21[R/W] B,H,W 11-11111 11111111		IF2MSK11[R/W] B,H,W 11111111 11111111		
002148_H	IF2ARB21[R/W] B,H,W 00000000 00000000		IF2ARB11[R/W] B,H,W 00000000 00000000		
$00214C_H$	IF2MCTR1[R/W] B,H,W 00000000 0---0000		-		
002150_H	IF2DTA11[R/W] B,H,W 00000000 00000000		IF2DTA21[R/W] B,H,W 00000000 00000000		
002154_H	IF2DTB11[R/W] B,H,W 00000000 00000000		IF2DTB21[R/W] B,H,W 00000000 00000000		
002158_H, $00215C_H$	-		-		
002160_H, 002164_H	Reserved (IF2 data mirror)				
002168_H | $00217C_H$	-		-		
002180_H	TREQR21[R] B,H,W 00000000 00000000		TREQR11[R] B,H,W 00000000 00000000		
002184_H	TREQR41[R] B,H,W 00000000 00000000		TREQR31[R] B,H,W 00000000 00000000		
002188_H	-		-		
$00218C_H$	-		-		
002190_H	NEWDT21[R] B,H,W 00000000 00000000		NEWDT11[R] B,H,W 00000000 00000000		
002194_H	NEWDT41[R] B,H,W 00000000 00000000		NEWDT31[R] B,H,W 00000000 00000000		
002198_H	-		-		
$00219C_H$	-		-		
$0021A0_H$	INTPND21[R] B,H,W 00000000 00000000		INTPND11[R] B,H,W 00000000 00000000		
$0021A4_H$	INTPND41[R] B,H,W 00000000 00000000		INTPND31[R] B,H,W 00000000 00000000		
$0021A8_H$	-		-		
$0021AC_H$	-		-		
$0021B0_H$	MSGVAL21[R] B,H,W 00000000 00000000		MSGVAL11[R] B,H,W 00000000 00000000		

Address	Address offset value/Register name				Block
	+0	+1	+2	+3	
003124_H	BUSADR4[R] W 00000000 00000000 00000000 00000000				Bus diagnosis
003128_H | $003FFC_H$	-	-	-	-	Reserved
004000_H | $005FFC_H$	Backup RAM				Backup RAM area
006000_H | $00CFFC_H$	-	-	-	-	Reserved
$00D000_H$	CIF0[R] W 00000100 11111111 01011011 11111111				FlexRay CIF
$00D004_H$	CIF1[R/W] W 00000000 -------0 -0000000 --------				
$00D008_H$ | $00D00C_H$	-	-	-	-	Reserved
$00D010_H$	-				FlexRay GIF
$00D014_H$	-				
$00D018_H$	-	-	-	-	
$00D01C_H$	LCK[R/W] W -------- -------- -------- 00000000				
$00D020_H$	EIR[R/W] W -----000 -----000 ----0000 00000000				FlexRay INT
$00D024_H$	SIR[R/W] W ------00 ------00 00000000 00000000				
$00D028_H$	EILS[R/W] W -----000 -----000 ----0000 00000000				
$00D02C_H$	SILS[R/W] W ------11 ------11 11111111 11111111				
$00D030_H$	EIES[R/W] W -----000 -----000 ----0000 00000000				
$00D034_H$	EIER[R/W] W -----000 -----000 ----0000 00000000				
$00D038_H$	SIES[R/W] W ------00 ------00 00000000 00000000				
$00D03C_H$	SIER[R/W] W ------00 ------00 00000000 00000000				
$00D040_H$	ILE[R/W] W -------- -------- -------- ------00				
$00D044_H$	T0C[R/W] W --000000 00000000 -0000000 ------00				
$00D048_H$	T1C[R/W] W --000000 00000010 -------- ------00				
$00D04C_H$	STPW1[R/W] W --000000 00000000 --000000 -0000000				
$00D050_H$	STPW2[R] W -----000 00000000 -----000 00000000				
$00D054_H$ | $00D07C_H$	-	-	-	-	Reserved

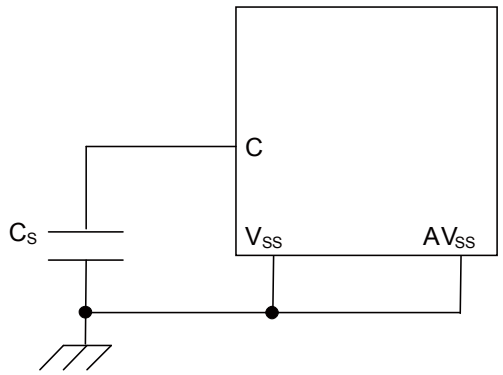
2. Recommended operating conditions

(V_{SS}= AV_{SS}=0.0V)

Parameter	Symbol	Value		Unit	Remarks
		Min	Max		
Power supply voltage	V_{CC}	4.5	5.5	V	Recommended operation guarantee range
	AV_{CC}	4.5	5.5	V	
	V_{CC}	3.7	5.5	V	Operation guarantee range
	AV_{CC}	3.7	5.5	V	
Smoothing capacitor*1	C_S	4.7 (tolerance within ±50%)		µF	Use a ceramic capacitor or a capacitor that has the similar frequency characteristics. Use a capacitor with a capacitance greater than C_S as the smoothing capacitor on the VCC pin.
Operating temperature	T_A	-40	+125	°C	*2

*1: For connection of smoothing capacitor C_S, see the figure below.
*2: When it is used exceeding T_A=125°C, contact your sales representative.

- C Pin Connection Diagram



WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.
Always use semiconductor devices within their recommended operating condition ranges.
Operation outside these ranges may adversely affect reliability and could result in device failure.
No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

(T_A: Recommended operating conditions, Vcc=5.0V±10%, V_{SS}= AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
"L" level output voltage	V_{OL1}	P000 to P007, P010 to P017, P020 to P027, P030 to P037, P040 to P042, P043 to P047*, P050 to P057*, P060 to P067, P070 to P077, P080 to P087, P090 to P097, P100 to P107, P110 to P117, P120 to P127, P130 to P134, P136 to P137	Vcc=4.5V I_{OL}=2.0mA	0	-	0.4	V	
	V_{OL2}	P003 to P007, P010	Vcc=4.5V I_{OL}=4.0mA	0	-	0.4	V	When FlexRay is selected
	V_{OL3}	P000 to P002, P011 to P017, P020 to P027, P030 to P037, P040 to P042, P043 to P047*, P050 to P057*, P060 to P067, P070 to P077, P080 to P087, P090 to P097, P100 to P107, P110 to P117, P120 to P127, P130 to P134, P136 to P137	Vcc=4.5V I_{OL}=5.0mA	0	-	0.4	V	
	V_{OL4}	P001,P002, P021,P022, P025,P026, P073,P074, P076,P077, P127,P130	Vcc=4.5V I_{OL}=3.0mA	0	-	0.4	V	I^2C shared pin (when I^2C is selected)
	V_{OL5}	DEBUGIF	Vcc=2.7V I_{OL}=25.0mA	0	-	0.25	V	

*: Only available with MB91F585LB/F586LB/F587LB, MB91F585LD/F586LD/F587LD

(T_A: Recommended operating conditions, Vcc=5.0V±10%, V_{SS}= AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current	I_{CC}	VCC5	Normal operations F_{CP}=128MHz, F_{CPP}=32MHz	-	85	110	mA	*1, *3 RDC=OFF, FlexRay =ON
				-	82	105	mA	*1, *3 RDC=ON, FlexRay =OFF
				-	85	110	mA	*2, *4 FlexRay =ON
				-	79	104	mA	*2, *4 FlexRay =OFF
			Normal operations F_{CP}=80MHz, F_{CPP}=40MHz	-	69	91	mA	*1, *3 RDC=OFF, FlexRay =ON
				-	67	89	mA	*1, *3 RDC=ON, FlexRay =OFF
				-	69	91	mA	*2, *4 FlexRay =ON
				-	64	87	mA	*2, *4 FlexRay =OFF
			Flash write F_{CP}=128MHz, F_{CPP}=32MHz	-	100	125	mA	*1, *3, *5
				-	100	125	mA	*2, *4, *5
			Flash erase F_{CP}=128MHz, F_{CPP}=32MHz	-	100	125	mA	*1, *3, *5
				-	100	125	mA	*2, *4, *5

*1: MB91F585LA/F586LA/F587LA
*2: MB91F585LB/F586LB/F587LB
*3: MB91F585LC/F586LC/F587LC
*4: MB91F585LD/F586LD/F587LD
*5: This series has 2 types of flash; main flash and WorkFlash; however, this is the specification when only one of those is written/erased.